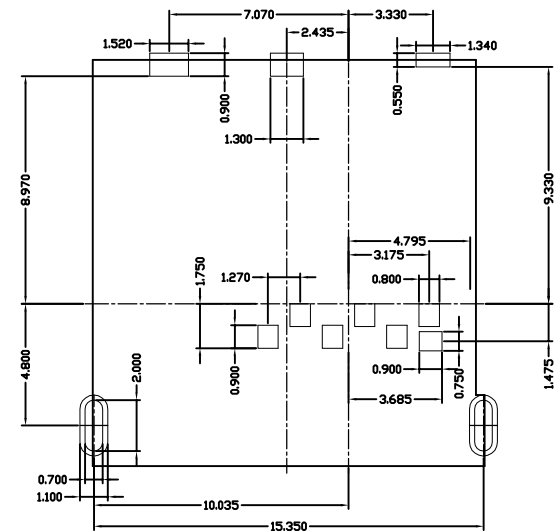
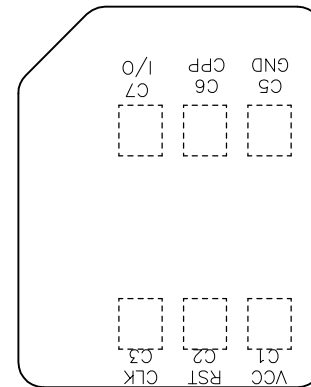
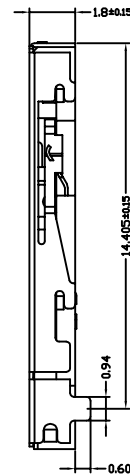
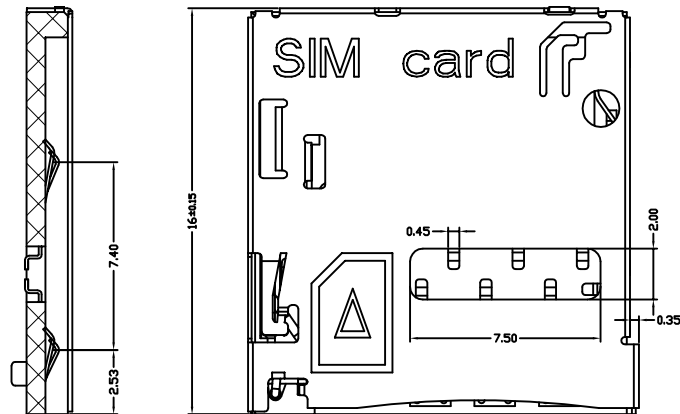
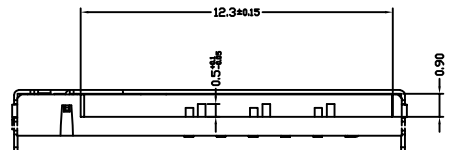
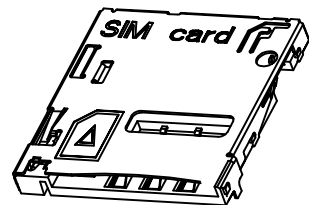


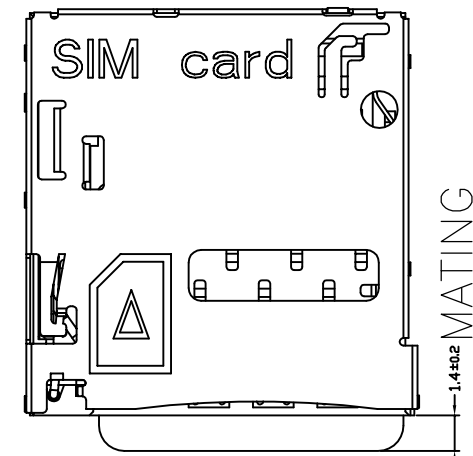
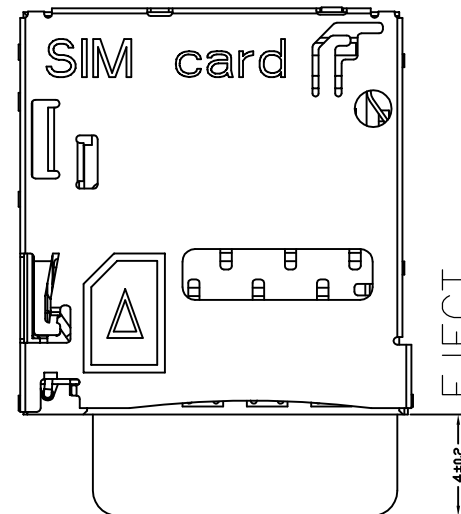
REV.	ECN.NO.	MODIFY.CONTENT	DATE
A			



RECOMMENDED PCB LAYOUT
TOL: (±0.05)



OTHER ALL SHELL



NOTE:

1. MATERIAL:

- A. HOUSING: LCP, UL 94-V0 COLOR: BLACK.
- B. CONTACT: PHOSPHOR BRONZE T=0.12mm
- C. SHELL: SUS 304 1/2H T=0.15mm

2. PLATING:

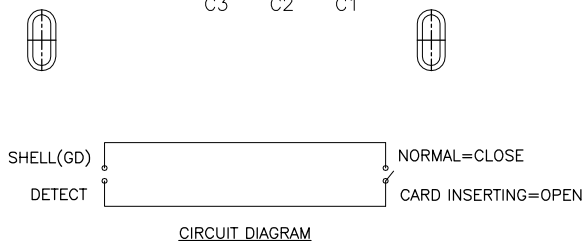
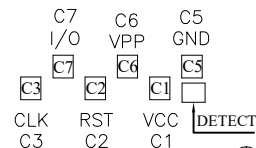
- Underplate: 50~80u" Nickel
- Contact area: 3~30u" Gold
- Solder tails area: 3u" Gold
- Shell: 50~80u" Nickel

3. ELECTRICAL CHARACTERISTICS:

- A. Operating voltage: 30V(AC/DC).
- B. Current rating: 1AMP MAX
- C. Operating temperature: -20°C~+85°C.
- D. Insulation resistance: 1000M ohm min. at 200VDC.
- E. Dielectric withstanding voltage: 500 VAC/1minute.
- F. Contact resistance: 30m ohm max.

4. MECHANICAL CHARACTERISTICS:

- A. Durability: 1500cycles
- B. Operating force(inserting & withdrawal): 1N~10N



GENERAL TOLERANCE		图 号	设 计	Achilles	比 例	1:1
X.±0.35	x.'±5°	品 名	MICRO SIM CARD	审 核	單 位	mm
.X±0.25	.x'±2°		PUSH TYPE 1.8H	核 准	视 角	⊙
.XX±0.15	.xx'±1°	料 號	5001B-SIM180-136	日 期	2016/01/09	版 本 A
.XXX±0.05	.xxx'±0.5°					
SHEET	1/1				东莞市文章济美电子有限公司	